



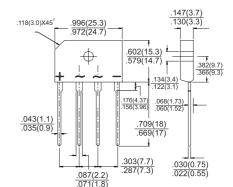


Glass Passivated Bridge Rectifiers

TS4B

TS4B01G - TS4B07G

Single Phase 4.0 AMPS.



Features

- UL Recognized File # E-96005
- \diamond Glass passivated junction
- \diamond Ideal for printed circuit board
- Reliable low cost construction
- Plastic material has Underwriters Laboratory Flammability Classification 94V-0
- Surge overload rating to 120 amperes peak
- \diamond High case dielectric strength of 2000V_{RMS}
- High temperature soldering guaranteed: 260 °C / 10 seconds at 5 lbs. (2.3 Kg) tension

Mechanical Data

Dimensions in inches and (millimeters)

Case: Molded plastic

 \diamondsuit Weight: 0. 15 ounce, 4 grams Mounting torque: 5 in. lbs. Max.

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

Type Number	Symbol	TS4B 01G	TS4B 02G	TS4B 03G	TS4B 04G	TS4B 05G	TS4B 06G	TS4B 07G	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T _C = 115 °C	I _(AV)	4.0							Α
Peak Forward Surge Current, 8.3 ms Single Half Sne-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	120							Α
Maximum Instantaneous Forward Voltage @ 2.0A @ 4.0A	V _F	1.0 1.1						V	
Maximum DC Reverse Current @ T _A =25 °C at Rated DC Blocking Voltage @ T _A =125 °C	I _R	5.0 500							uA uA
Typical Thermal Resistance (Note)	R _{0JC}	5.5							°C/W
Operating Temperature Range	TJ	-55 to +150							°C
Storage Temperature Range	T _{STG}	-55 to + 150							°C

Note: Thermal Resistance from Junction to Case with Device Mounted on 2" x 3" x 0.25" Al-Plate Heatsink.



RATINGS AND CHARACTERISTIC CURVES (TS4B01G THRU TS4B07G)

